



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Application Number : 10/724,093 Confirmation No. 1410  
Applicant : Sang Wook Ryu et al.  
Filed : December 1, 2003  
Tech Cntr/AU : 2891  
Examiner : Chandra P. Chaudhari  
Entitled : METHOD FOR FORMING METAL LINE IN SEMICONDUCTOR DEVICE  
Attorney Reference : 123034-05004797  
Customer Number : 43569

**MAIL STOP AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

**AMENDMENT/RESPONSE TRANSMITTAL**

Transmitted herewith is an amendment/response for this application.

**EXTENSION OF TIME**

A petition for extension of time under 37 C.F.R. 1.136 is not believed necessary.

**CLAIM FEES**

The claim fees have been calculated as follows:

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total	4	-	20 = 0	x \$ 50.00	= \$ 0.00
Independent	1	-	3 = 0	x \$ 200.00	= \$ 0.00
FIRST PRESENTATION OF MULTIPLE DEP. CLAIM+ \$					\$ 360.00
TOTAL ADDITIONAL CLAIM FEE DUE					\$ 0.00

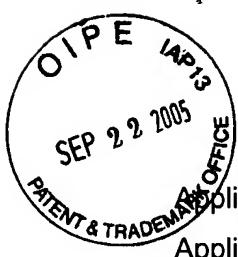
**FEE PAYMENT**

Authorization is given herein to charge the any deficiencies in the fees not specifically authorized herein, or to further credit any overpayments, to Deposit Account No. 503-121 in order to maintain the pendency of this application.

Intellectual Property Department  
Mayer Brown Rowe & Maw LLP  
1909 K Street, N.W.  
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Date: September 22, 2005



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**RESPONSE UNDER 37 C.F.R. § 1.111**

Sir:

In response to the Office Action dated June 23, 2005 for the above-identified application, amendments and/or remarks submitted herewith include:

- A complete claim listing; and
- Remarks and arguments.